

MAKE YOUR OWN 3D PRINTER WITH NXP TECHNOLOGY

FTF-SMI-2003

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PRESENTER TITLE
FTF-SMI-2003
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AGENDA

- What is a 3D Printer?
- Understand the basics of 3D printing
- Understand the basics of assembling a 3D printer
- How can NXP help enable your 3D printer build?
- What are the Electronics involved in creating a 3D printer?



What is 3D Printing?

Most printers today are FFF type:
Fused Filament
Fabrication





What Are the Parts that Make Up 3D Printing?

- Printer frame
- Printer mechanical slides
- Print head
- Stepper motors
- Print bed heated
- Display
- SD card printing files
- Power supply
- Slicing software G-code conversion
- Plastic filament
- ELECTRONICS!!!!

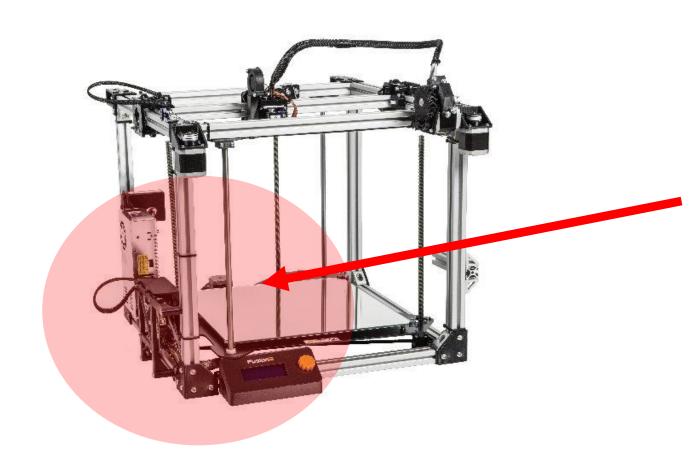


How Can NXP Help Me Enable My 3D Printer? ... Electronics!

- NXP has just about everything in the electronics that you need to get your 3D printer up and running!
 - Microcontrollers ARM® Cortex® Core-M0+, M4
 - Power supply components
 - Motor control components
 - MOSFETS
 - DC-to-DC converters
 - Transistors
 - Temperature sensors
 - H-Bridge pre-drivers
 - Motor Control Software Kinetis motor suite!
 - Stepper motor control library code



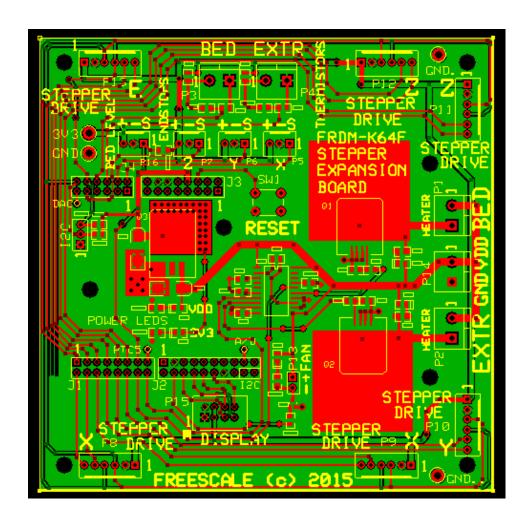
See Where NXP Can Help Enable Your Design for Hardware!

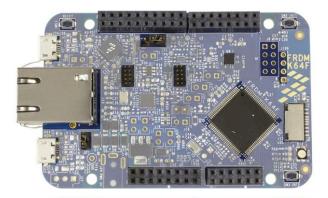


Microcontrollers – ARM M0+, M4
Power supply components
Motor control components
MOSFETS
DC-to-DC converters
Transistors
Temperature sensors
H-Bridge pre-drivers



Custom Hardware Using the FRDM-K64F, FRDM-KV31, MC33932EK EVB Boards



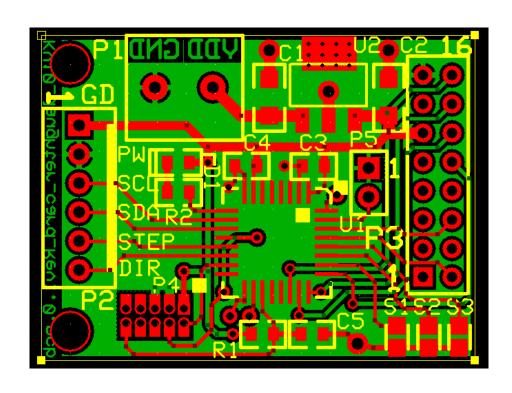








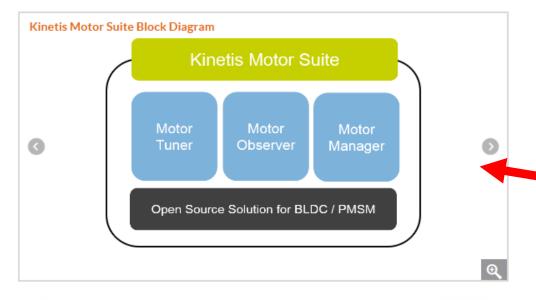
Custom Hardware Using the MKV10 Microcontroller as Motor Drives



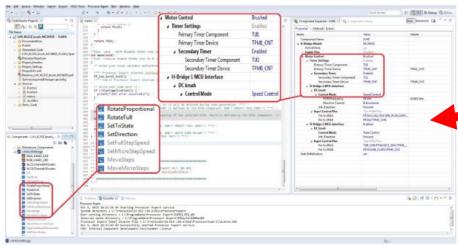




See Where NXP Can Help Enable Your Design for Software!



Motor Control Software -Kinetis Motor Suite!



Stepper Motor control library code



COME DOWN TO THE TECH LAB TO SEE A DEMONSTRATION OF THE NXP 3D PRINTER!



SENSOR PRODUCTS TIMELINE



1980

We manufacture our first uncompensated pressure sensor



Production

start of First

1981 1982

Pressure sensors are supplied Development of for manifold absolute Temperature pressure (MAP), enabling a Sensor KTY81 major reduction in emissions KMZ10 and fuel consumption



1985

first magnet

sensor family

1985

A temperature-

pressure sensor

compensated

is unveiled



ABS sensor

1991

Development of first Bipolar integrated pressure sensor production begins

,....,



1992—present

Dedicated supplier to the critical care medical market shipping over 90 million units for the invasive blood pressure market



Start angular sensor Production KMZ41

Start production Compass sensor KMZ51

1995



1996

Inertial sensors

start volume

production

1996

Start production Integrated ABS Sensor family



Late 1990s

A new wingback/PDIP package is developed for the Z-axis inertial sensor



Early 2000s

Inertial sensor portfolio expands with X-, XY- and Z-axis low-g products



2002

2003

Began providing pressure sensors for respiratory medical equipment



Tire pressure monitoring system developed, utilizing capacitive technology to save power



2003

Smarter, faster airbag deployment enabled by satellite accelerometer introduction



2003

shipped

100 mill sensors

2004

Launch integrated angular sensor system KMA200

......



May 2005

Freescale introduces its first 3-axis MMA7260Q low-q inertial senso



July 2006

First HARMEMS technology MMA62xxEG products shipped for airbags with robust accuracy

2011



2007

2008

Launch TPMS highly integrated, singleintegrated package, low-power solution introduced with pressure sensor, angular sensor system 8-bit MCU, RF transmitter, 2-axis X- and Z-axis accelerometer KMA199



November 2008

Synerject announces its ongoing use of Freescale pressure sensors for robust, cost-effective ECUs for two- and four-stroke engine laptop hard disks management ______



December 2008

3-axis accelerometers offer reliable, cost-effective first digital barometric freefall detection to help protect data stored on



June 2009

MPL115A released, the pressure sensor with easy-to-use digital interface and low power



January 2010

Freescale Sensors Group marks thirty years of industry innovation and leadership



February 2010

MMA845xQ unveiled, a very low- power 12-bit digital (I²C) resolution accelerometer with embedded functions to enable next-generation intelligent motion features



June 2010

Freescale launches Xtrinsic sensing solutions, the first smart sensors in the market



January 2011

Freescale introduces the first magnetometer in its Xtrinsic sensor portfolio



2011 Launch

BL DC

Sensor

KMZ60

Select Comfort launches production using differential pressure sensors to enable tracking & sleep optimization through SleepIQ



Award-winning

Xtrinsic eCompass

software introduced



February 2012 2012

MPL3115A2 altimeter released



Launch throttle Sensor KMA220



June 2012

Joint announcement with Kinetis introducing the MMA8491Q



June 2012

Accelerometers for smart meter physical tamper detection debut



2013

Wide bandwidth 3 axis accelerometer for vibration sensing applications launched



August 2013

Xtrinsic MMA9550L motionsensing platform detects falls and an Xtrinsic MAG3110 3-axis magnetometer works in conjunction for accurate compass-based location information in Numera's Personal Emergency Response System



October 2013

Gyroscope sampling



2014

Launch angular sensor with SENT output



2014

Alternative Fuel (LPG) after-market gyroscope installs with ported pressure sensors



2014

First 3 axis launched-FXA21002



2015

MPL3115A2 altimeter used in inhaler applications



used to detect

amount of beer

remaining

2016

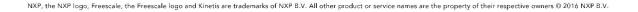
Ikeg uses ported Launch of first differential sensor monolithic integrated MR sensor



2016

Reached 3 billion sensors shipped milestone





Other Sensor Sessions This Week

Session	Day	Time	Title	Room
FTF-SMI-N1946	Monday	16:15	Build Better Drones with NXP Products	301 & 302 – Level 3*
FTF-AUT-N1821	Tuesday	11:00	Automotive Sensors Portfolio	Lone Star Ballroom E - Level 3
FTF-INS-N1820	Tuesday	14:30	Hands-On Workshop: Sensor Mining and Algorithm Development (Reserved Seat Required)	Griffin Hall 1 - Level 2
FTF-INS-N2014	Wednesday	11:00	Collecting and Analyzing Sensor Data Readily using NXP Hardware and Software Tools Including Kinetis SDK and IS-SDK	Lone Star Ballroom H - Level 3
FTF-INS-N1819	Wednesday	14:30	Sensor Deep-Dive Demos and Data Collection Techniques	Lone Star Ballroom H - Level 3
FTF-INS-N1816	Wednesday	16:45	Sensors for Industrial and Medical IoT Applications	301 & 302 - Level 3
FTF-INS-N1818	Thursday	9:00	The Fundamentals of Sensor Data Analytics	301 & 302 - Level 3
FTF-INS-N1817	Thursday	09:00	Introduction to Sensor Toolbox and IoT Sensing SDK	Lone Star Ballroom F – Level 3
FTF-SMI-N2003	Thursday	11:00	Make Your Own 3D Printer with NXP Technology	Lone Star Ballroom G - Level 3

^{*} Cross BU session, intro to sensors for drones



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